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Part Number: [0432028918](#)
Status: **Active**
Overview: [modular_plugs_jacks](#)
Description: Modular Jack, Right Angle, Low Profile, Shielded, Offset Panel Grounding Tabs, with Bottom Grounding Tab, Front Position PCB Ground Tab, 8/8

Documents:
[3D Model](#) [Product Specification PS-43202-001 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA LR19980
UL E107635

General

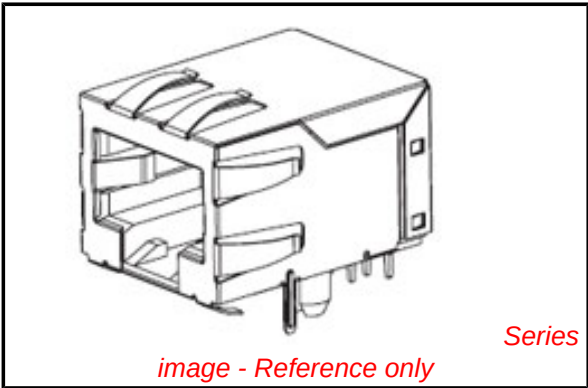
Product Family Modular Jacks/Plugs
Series [43202](#)
Comments Enhanced panel grounding tabs
Component Type PCB Jack
Magnetic No
Overview [modular_plugs_jacks](#)
Performance Category 3
Power over Ethernet (PoE) N/A
Product Name RJ45

Physical

Color - Resin Black
Durability (mating cycles max) 500
Flammability 94V-0
Inverted / Top Latch No
Lightpipes/LEDs None
Material - Metal Brass, Phosphor Bronze
Material - Plating Mating Gold
Material - Plating Termination Tin
Material - Resin High Temperature Thermoplastic
Orientation Right Angle (Side Entry)
PCB Retention Yes
PCB Thickness Recommended (in) 0.062 In
PCB Thickness Recommended (mm) 1.60 mm
Packaging Type Tray
Panel Mount With Flange
Pitch - Mating Interface (in) 0.050 In
Pitch - Mating Interface (mm) 1.27 mm
Plating min: Mating (µin) 50
Plating min: Mating (µm) 1.25
Plating min: Termination (µin) 100
Plating min: Termination (µm) 2.5
Ports 1
Positions / Loaded Contacts 8/8
Surface Mount Compatible (SMC) Yes
Temperature Range - Operating -40°C to +85°C
Termination Interface: Style Through Hole
Wire/Cable Type N/A

Electrical

Current - Maximum per Contact 1.5A



EU RoHS

**ELV and RoHS
Compliant**

REACH SVHC

Not Reviewed

Halogen-Free

Status

Not Reviewed

China RoHS



**Need more information on product
environmental compliance?**

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of
Compliance, [click here](#)

Please visit the [Contact Us](#) section for any
non-product compliance questions.

Search Parts in this Series

[43202Series](#)

Mates With

FCC 68 Plugs

Grounding to PCB	Yes
Grounding to Panel	Offset Panel Ground Tabs
Shielded	Yes
Voltage - Maximum	125V

Solder Process Data

Lead-free Process Capability	Wave Capable (TH only)
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Material Info

Reference - Drawing Numbers

Packaging Specification	PK-43202-004
Product Specification	PS-43202-001, RPS-43202-002
Sales Drawing	SDA-43202

This document was generated on 06/07/2010

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NOTES:

1) MATERIAL:

HOUSING: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE SHEETS 5 AND 6
INSULATOR: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE SHEETS 5 AND 6
TERMINALS: PHOSPHOR BRONZE, .012/ 0.30 THICK
SHIELD: BRASS, .007/ 0.18 THICK

2) FINISH:

TERMINALS:

A = SELECT GOLD IN CONTACT AREA: 50 MICROINCHES / 1.27 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
B = SELECT GOLD IN CONTACT AREA: 30 MICROINCHES / 0.76 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS AND/OR SHIELD.

SHIELD:

100 MICROINCHES / 2.54 MICROMETERS NICKEL OVER 50 MICROINCHES / 1.27
MICROMETERS COPPER UNDERPLATE PCB GROUND TABS DIPPED IN TIN

3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43202.

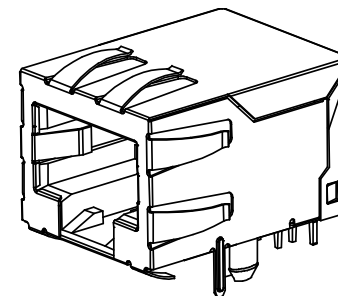
4) PACKAGING SPECIFICATION:

UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43202-003.
UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN TUBES
PER MOLEX PACKAGING SPECIFICATION PK-43202-005.
SHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43202-004.

5) SEE SHEETS 7 - 9 FOR P.C. BOARD LAYOUTS.

6) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.

7) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.



SHIELDED MODULAR JACK
SHOWN WITH PANEL GROUND
OPTION 'D' AND FRONT
PCB GROUND TABS.

DRAWING LEGEND

SHEET 1- NOTES, DRAWING LEGEND
SHEET 2- SHIELDED MODULAR JACK W/ BOTTOM GROUND TABS
SHEET 3- SHIELDED MODULAR JACK W/O BOTTOM GROUND TABS
SHEET 4- UNSHIELDED MODULAR JACK
SHEET 5- PART NUMBER CHARTS
SHEET 6- PART NUMBER CHARTS
SHEET 7- FOOTPRINT LAYOUT FOR 4 POSITION HOUSING
SHEET 8- FOOTPRINT LAYOUT FOR 6 POSITION HOUSING
SHEET 9- FOOTPRINT LAYOUT FOR 8 POSITION HOUSING

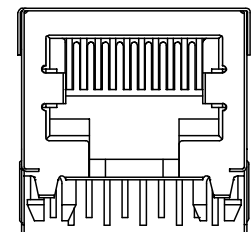
OBS COLORED JACKS EC NO: UCP2008-1189 DRAWN:JBELL 2007/11/30 CHKD:LSCHMIDT 2008/02/20 APPR:FSM/TH 2008/03/04	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	 THIRD ANGLE PROJECTION	
				mm	INCH	DRAWN BY JTR	DATE 1993/03/31	TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY		
			4 PLACES	±---	±---	CHECKED BY JTR	DATE 1993/03/31	MOLEX INCORPORATED		
			3 PLACES	±---	±.010					
			2 PLACES	±0.25	±.014	APPROVED BY RAS	DATE 1993/03/31			
			1 PLACE	±0.36	±---					
			ANGULAR ±1/2°		MATERIAL NO. SEE SHTS 5&6		DOCUMENT NO. SDA-43202	SHEET NO. 1 OF 9		
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

9	L2
8	L2
7	L2
6	L4
5	L
4	K2
3	L1
2	L1
1	L4
SH	REV

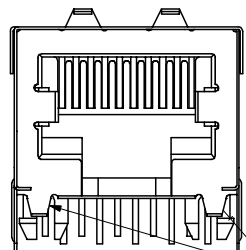
SHIELDED MODULAR JACK W/BOTTOM GROUND TABS

SIZE 8 LOADED 10 VERSION SHOWN

SIDE/TOP GROUND TAB OPTIONS FOR SHIELDS



OPTION "A"
NO TOP OR SIDE TABS

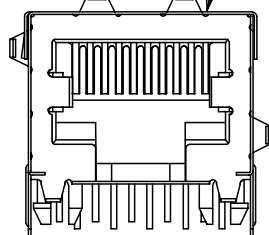


OPTION "B"
TOP TABS

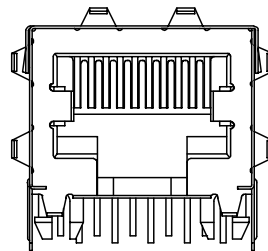
BOTTOM
GROUND TABS

OPTIONAL TOP GROUND TABS

SHIELDED MODULAR JACK ASSEMBLY
SEE SHEET 5 FOR MATERIAL NO.

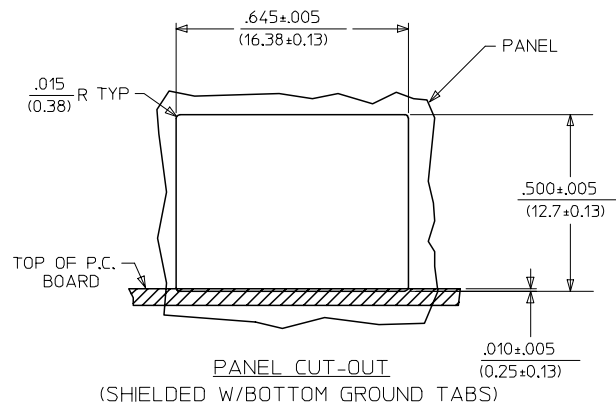
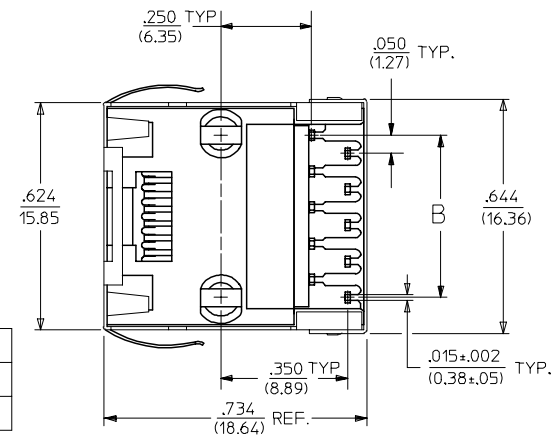
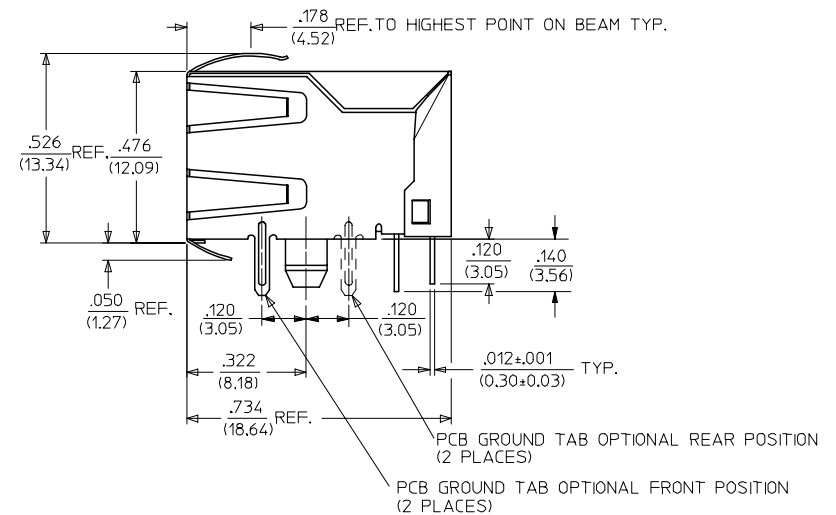


OPTION "C"
TOP AND STAGGERED SIDE TABS



OPTION "D"
TOP AND SIDE TABS

OPTIONAL SIDE
GROUND TABS
(2 PLACES)



HOUSING SIZE	CIRCUIT SIZE	B
8	10	.450±.005 11.43±.13
8	8	.350±.005 8.89±.13

SEE SHEET ONE EC NO: UCP2004-1888 DRAWN: SCHMIDT 2004/03/31 CHKD: SCHMIDT 2004/03/31 APPR: FSMITH 2004/03/31 REV L1	QUALITY SYMBOLS ▽ - 0 ▽ - 0	GENERAL TOLERANCES (UNLESS SPECIFIED)	mm		INCH		SCALE 4:1	DESIGN UNITS INCH		THIRD ANGLE PROJECTION	REVISE ON CAD ONLY	TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY	MATERIAL NO. SEE SHT 5	DOCUMENT NO. SDA-43202	SHEET NO. 2 OF 9				
			DIMENSION STYLE IN/MM																
			4 PLACES ±---		±---											DRAWN BY JTR		DATE 1993/03/31	
			3 PLACES ±---		±.010											CHECKED BY JTR		DATE 1993/03/31	
			2 PLACES ±0.25		±.014											APPROVED BY RAS		DATE 1993/03/31	
			1 PLACE ±0.36		±---											DRAFT WHERE APPLICABLE			
			ANGULAR ±1/2°													THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			

	13	12	11	10	9	8	7	6	5	4	3	2	43202		
J	SHIELDED MODULAR JACKS W/BOTTOM GROUND TABS (SHEET 2)														J
	ASSEMBLY MATERIAL NUMBER	CONNECTOR SIZE	NUMBER OF CIRCUITS	SIDE/TOP PANEL GROUND TAB OPTION	PCB GROUND TAB OPTION	TERMINAL PLATING OPTION	PACKAGING OPTION	HOUSING COLOR							
I	43202-8900	8	10	A	FRONT POSITION	A	TRAY	BLACK							
	43202-8901	8	10	B	FRONT POSITION	A	TRAY								
	43202-8902	8	10	C	FRONT POSITION	A	TRAY								
	43202-8903	8	10	D	FRONT POSITION	A	TRAY								
	43202-8908	8	10	A	REAR POSITION	A	TRAY								
H	43202-8909	8	10	B	REAR POSITION	A	TRAY								
	43202-8910	8	10	C	REAR POSITION	A	TRAY								
	43202-8911	8	10	D	REAR POSITION	A	TRAY								
	43202-8916	8	8	A	FRONT POSITION	A	TRAY								
	43202-8917	8	8	B	FRONT POSITION	A	TRAY								
G	43202-8918	8	8	C	FRONT POSITION	A	TRAY								
	43202-8919	8	8	D	FRONT POSITION	A	TRAY								
	43202-8924	8	8	A	REAR POSITION	A	TRAY								
	43202-8925	8	8	B	REAR POSITION	A	TRAY								
	43202-8926	8	8	C	REAR POSITION	A	TRAY								
	43202-8927	8	8	D	REAR POSITION	A	TRAY								
F														F	
E														E	
D														D	
C														C	
B														B	
A														A	
SEE SHEET 1 EC NO: UCP2004-1347 DRWN:MKAMARA0004/02/09 CHKD:MKAMARA0004/02/09 APPR:BWIKJUS 2004/02/10 QUALITY SYMBOLS ▽-0 ▽-0 DESCRIPTION REV GENERAL TOLERANCES (UNLESS SPECIFIED) 4 PLACES ±.000 ±.000 3 PLACES ±.000 ±.010 2 PLACES ±.025 ±.014 1 PLACE ±0.36 ±.000 ANGULAR ±1/2° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS SCALE 4:1 DESIGN UNITS INCH THIRD ANGLE PROJECTION REVISE ON CAD ONLY DIMENSION STYLE IN/MM TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY CHECKED BY JTR DATE 1993/03/18 MOLEX INCORPORATED APPROVED BY RAS DATE 1993/03/18 MATERIAL NO. SEE CHART DOCUMENT NO. SDA-43202 SHEET NO. 5 OF 9 THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION															
ib_frame_C_P_ME_T Rev. C 2002/05/05	12	11	10	9	8	7	6	5	4	3	2	1			

SEE SHEET 1
EC NO: UCP2004-1347
DRWN:MKAMARA0004/02/09
CHKD:MKAMARA0004/02/09
APPR:BMWKUS 2004/02/10

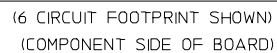
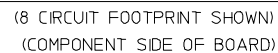
QUALITY
SYMBOLS
▽ - 0
▽ - 0

DESCRIPTION

GENERAL TOLERANCES
(UNLESS SPECIFIED)
mm INCH
4 PLACES ±.004 ±.004
3 PLACES ±.004 ±.010
2 PLACES ±.025 ±.014
1 PLACE ±.036 ±.004
ANGULAR ±1/2°
DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

SCALE
4:1
DESIGN UNITS
INCH
DIMENSION STYLE
IN/MM
DRAWN BY
JTR
DATE
1993/03/18
CHECKED BY
JTR
DATE
1993/03/18
APPROVED BY
RAS
DATE
1993/03/18
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INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

THIRD ANGLE
PROJECTION
REVISE ON CAD ONLY
TITLE
ULTRA LOW PROFILE
RIGHT ANGLE MODULAR JACK
ASSEMBLY
molex MOLEX INCORPORATED
MATERIAL NO.
SEE CHART
DOCUMENT NO.
SDA-43202
SHEET NO.
5 OF 9



NOTES:
1. RECOMMENDED PCB THICKNESS: .062±.005/(1.57±0.13)

ADD PCB THICKNESS

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

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